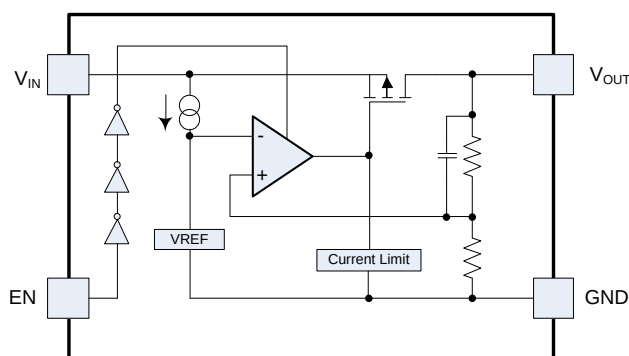


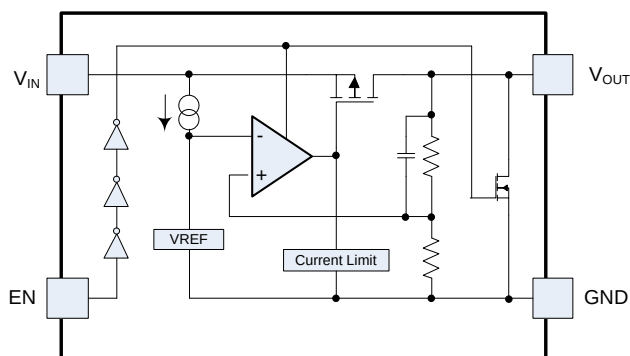
Pin Descriptions

Pin Number	Pin Name	Function
1	EN	Channel enable pin. This pin should be driven either high or low and must not be floating. Driving this pin high enables regulator output, while pulling it low enable regulator into shutdown mode.
2	GND	Ground
3	V _{OUT}	Output voltage pin
4	V _{IN}	Power input pin

Functional Block Diagram



AP7350 (Without Discharge)



AP7350D (With Discharge)

Absolute Maximum Ratings (Note 6)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
V _{IN}	Input Voltage	6.0	V
V _{EN}	Input Voltage at EN pin	6.0	V
V _{OUT}	Output Voltage to GND	-0.3 to V _{IN} +0.3	V
T _A	Operating Ambient Temperature	-40 to +85	°C
T _J	Maximum Junction Temperature	+125	°C
T _{STG}	Storage Temperature	-55 to +125	°C
P _D	Power Dissipation (Note 7)	315	mW

Notes: 6. Stresses beyond those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.
7. This is based on an application temperature of +40°C. Derate 3.75mW per °C for each degree above +40°C.

Recommended Operating Conditions

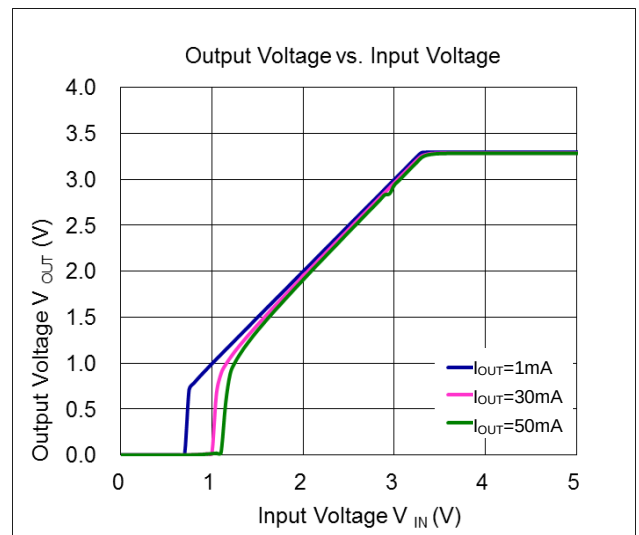
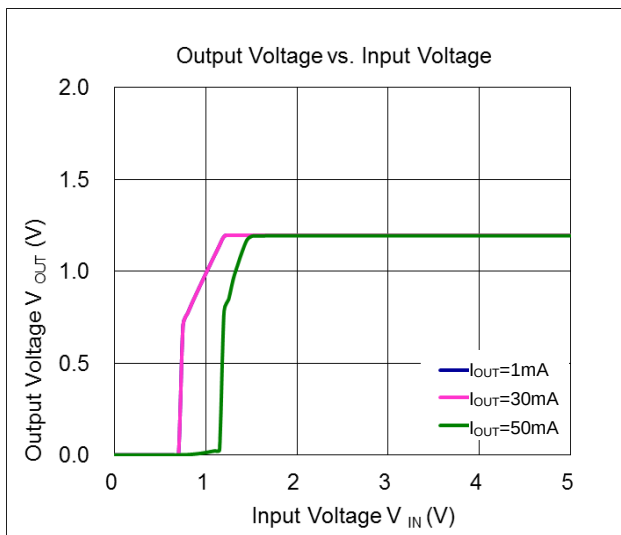
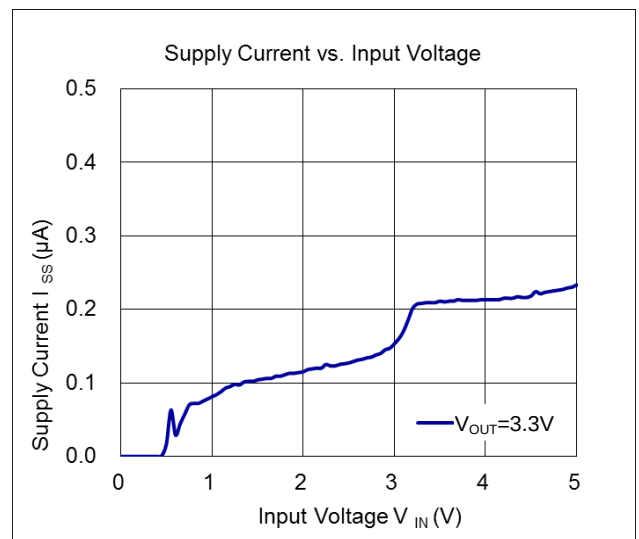
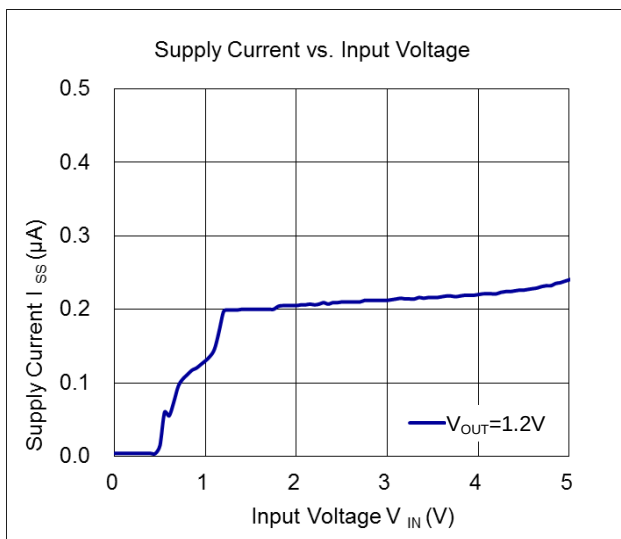
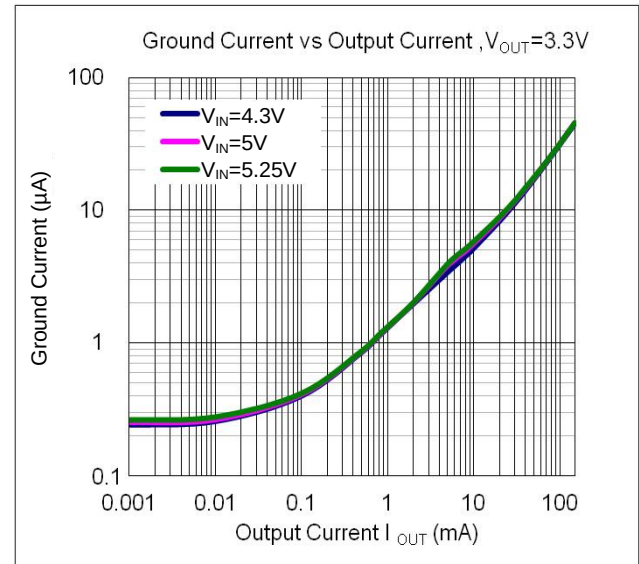
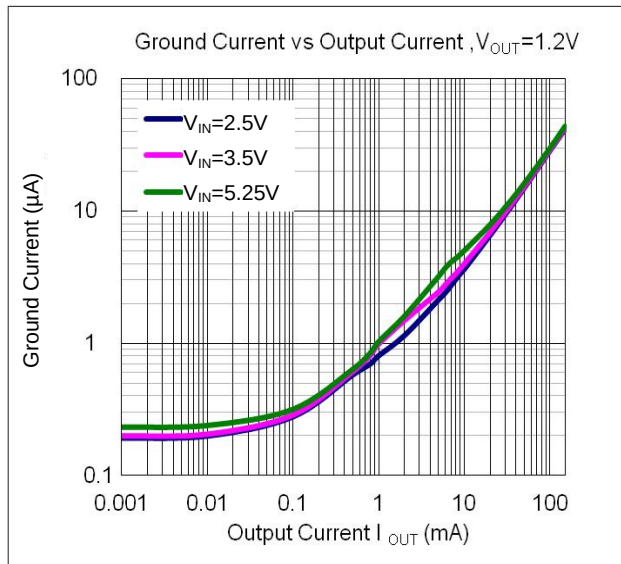
Symbol	Parameter	Min	Max	Unit
V_{IN}	Input Voltage	2.0	5.25	V
I_{OUT}	Output Current	0	150	mA
T_A	Operating Ambient Temperature	-40	+85	°C

Electrical Characteristics (@ $T_A = +25^{\circ}\text{C}$, $V_{EN} = V_{IN} = 5.0\text{V}$ ($V_{OUT} > 4.0\text{V}$), $V_{EN} = V_{IN} = V_{OUT} + 1\text{V}$ ($1.5\text{V} < V_{OUT} \leq 4.0\text{V}$), $V_{EN} = V_{IN} = 2.5\text{V}$ ($V_{OUT} \leq 1.5\text{V}$), $I_{OUT} = 1\text{mA}$, $C_{IN} = C_{OUT} = 0.1\mu\text{F}$, unless otherwise specified.)

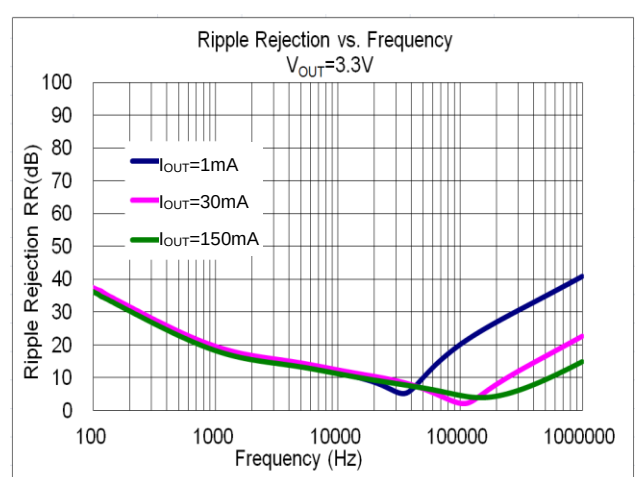
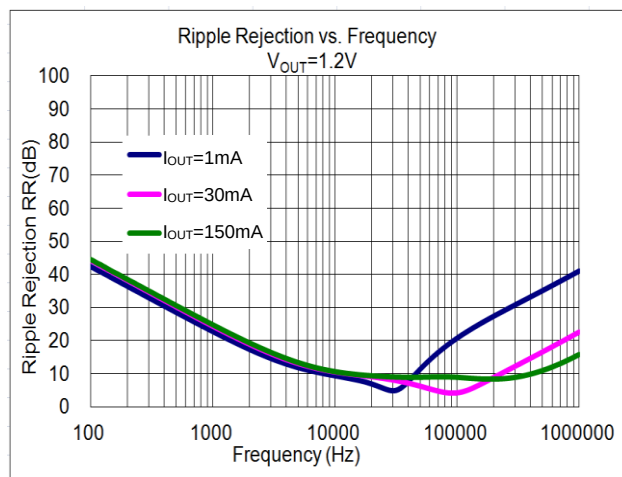
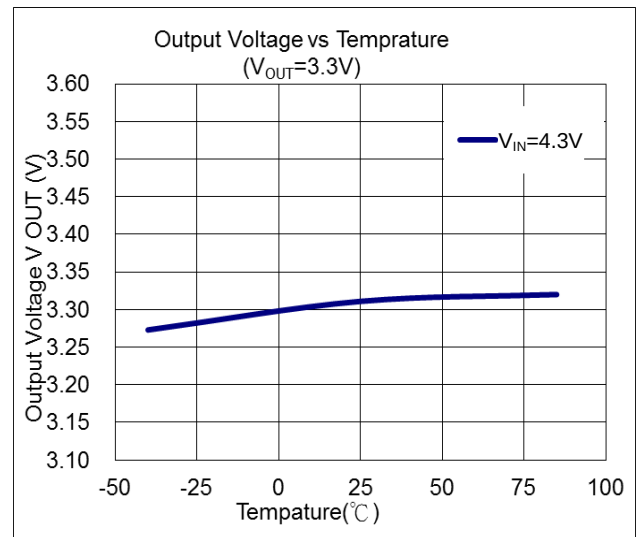
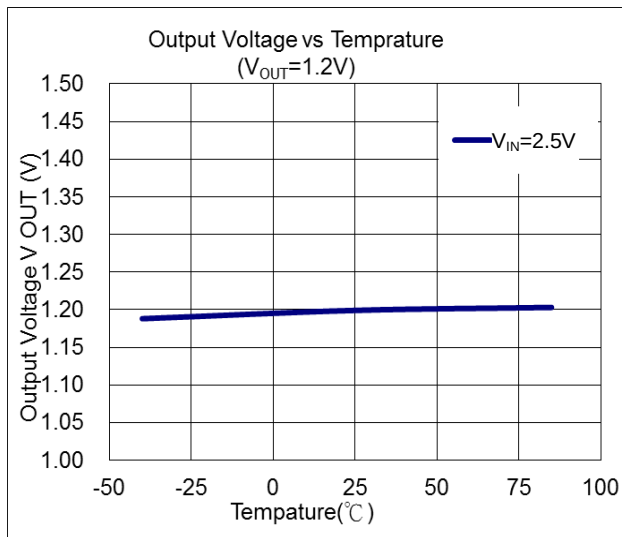
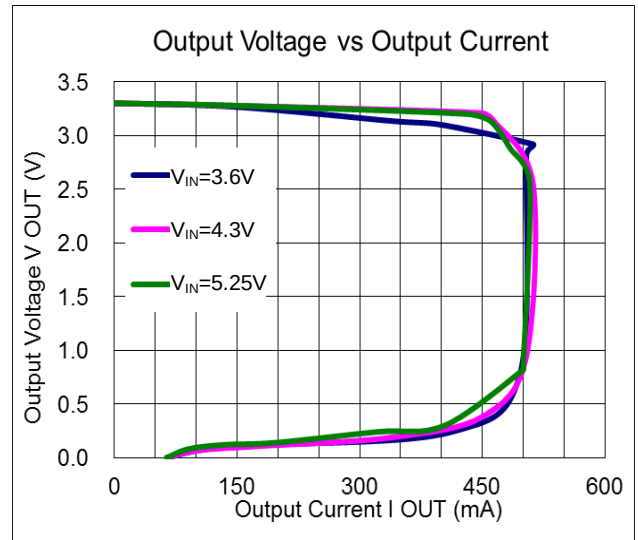
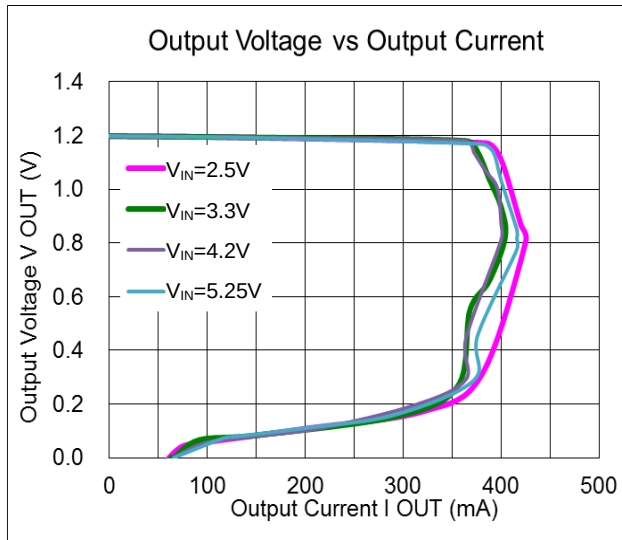
Parameter	Conditions	Min	Typ	Max	Unit
Input Voltage	$T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	2.0	—	5.25	V
Output Voltage Accuracy	$V_{OUT} > 2.0\text{V}$ $I_{OUT} = 1\text{mA}$ $T_A = +25^{\circ}\text{C}$	-1	—	+1	%
	$T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	-2	—	+2	
	$V_{OUT} \leq 2.0\text{V}$ $I_{OUT} = 1\text{mA}$ $T_A = +25^{\circ}\text{C}$	-40	—	40	mV
	$T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	-80	—	80	
Line Regulation ($\Delta V_{OUT}/\Delta V_{IN}/V_{OUT}$)	$\text{MAX } (V_{OUT} + 1.0\text{V}, 2.5\text{V}) \leq V_{IN} \leq 5.0\text{V}$	—	0.02	0.1	%/V
Load Regulation (ΔV_{OUT})	$1\text{mA} \leq I_{OUT} \leq 150\text{mA}$ (all versions except 4.5V)	-25	—	25	mV
	$1\text{mA} \leq I_{OUT} \leq 150\text{mA}$ (applicable to 4.5V version)	-45	—	45	mV
Short Circuit Current Limit (Note 8)	$V_{OUT} = 0\text{V}$	—	60	—	mA
Quiescent Current (Note 9)	$I_{OUT} = 0\text{mA}$ $T_A = +25^{\circ}\text{C}$	—	0.25	0.4	μA
	$T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	—	—	0.7	μA
Standby Current ($I_{STANDBY}$)	Set EN low, No load	—	0.02	0.2	μA
Output Current	$V_{IN} \geq V_{OUT} + V_{DROPOUT}$	150	—	—	mA
Dropout Voltage (Note 10)	$I_{OUT} = 150\text{mA}$	$V_{OUT} = 1.2\text{V}$	—	0.60	V
		$V_{OUT} = 1.5\text{V}$	—	0.43	
		$V_{OUT} = 1.8\text{V}$	—	0.33	
		$V_{OUT} = 1.85\text{V}$	—	0.32	
		$V_{OUT} = 2.3\text{V}$	—	0.25	
		$V_{OUT} = 2.5\text{V}$	—	0.22	
		$V_{OUT} = 2.7\text{V}$	—	0.21	
		$V_{OUT} = 2.8\text{V}$	—	0.19	
		$V_{OUT} = 3.0\text{V}$	—	0.18	
		$V_{OUT} = 3.3\text{V}$	—	0.16	
		$V_{OUT} = 4.5\text{V}$	—	0.14	
Thermal Resistance Junction-to-Ambient (θ_{JA}) (Note 11)	Package: X2-WLB0606-4	—	267	—	°C/W
EN Input Low Voltage	—	—	—	0.4	V
EN Input High Voltage	—	1.0	—	5.25	V
Active Output Discharge Resistance (Note 12)	$V_{IN} = 4.0\text{V}$, $V_{EN} = 0\text{V}$	—	35	—	Ω

- Notes:
- Short circuit current is measured with V_{OUT} pulled to GND.
 - Quiescent current defined here is the difference in current between the input and the output.
 - Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
 - Test condition: X2-WLB0606-4 is mounted on PCB (compliant with JEDEC standard).
 - AP7350 is available with 2 options: built-in discharge (AP7350D) and non-discharge (AP7350).

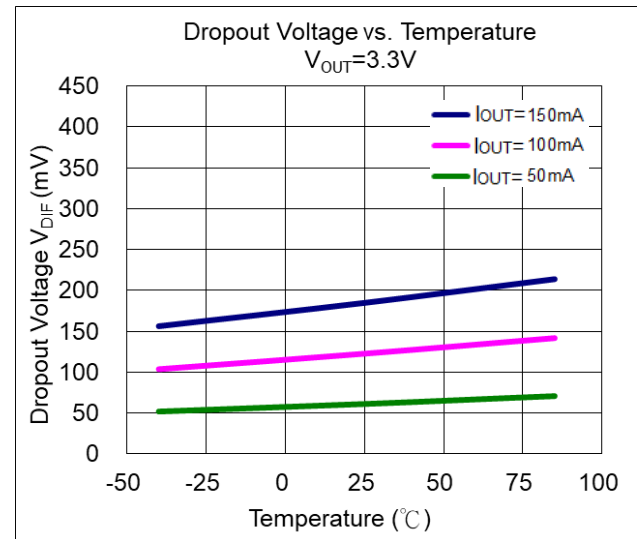
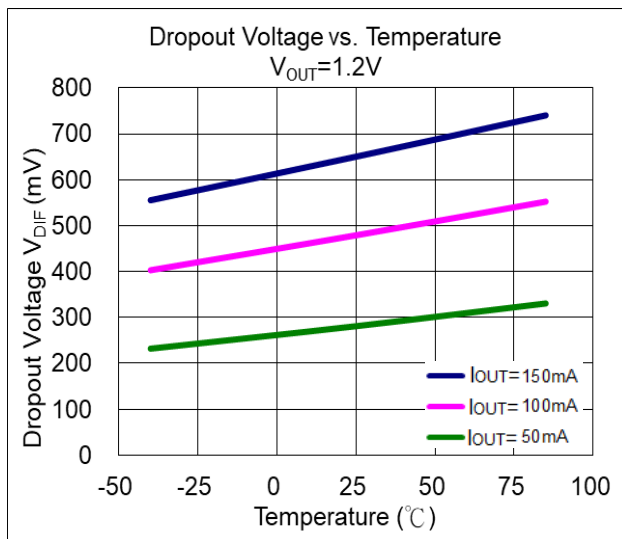
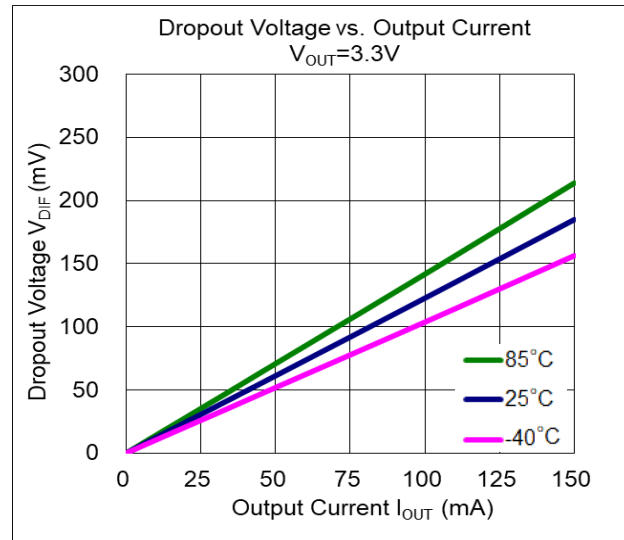
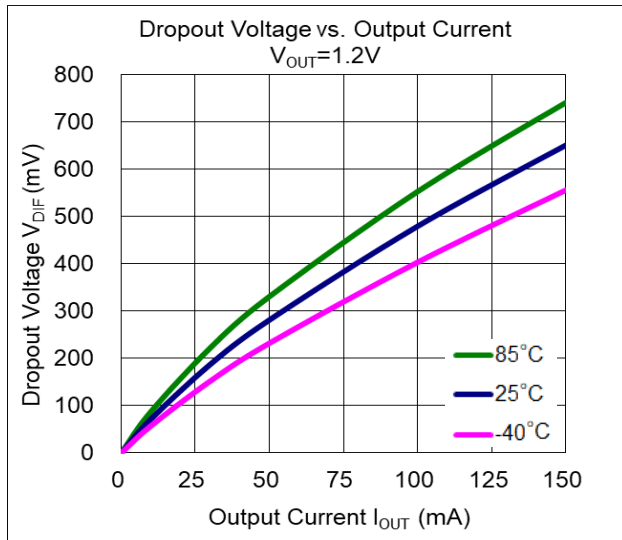
Performance Characteristics



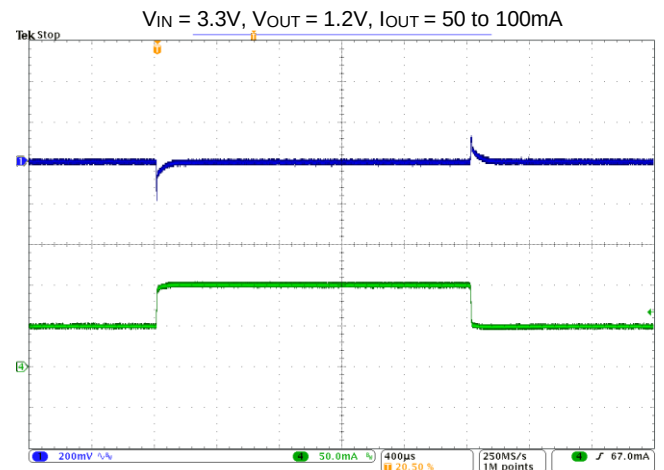
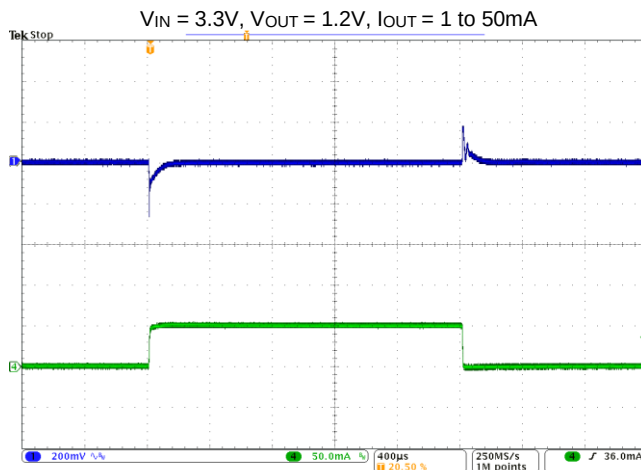
Performance Characteristics (continued)



Performance Characteristics (continued)

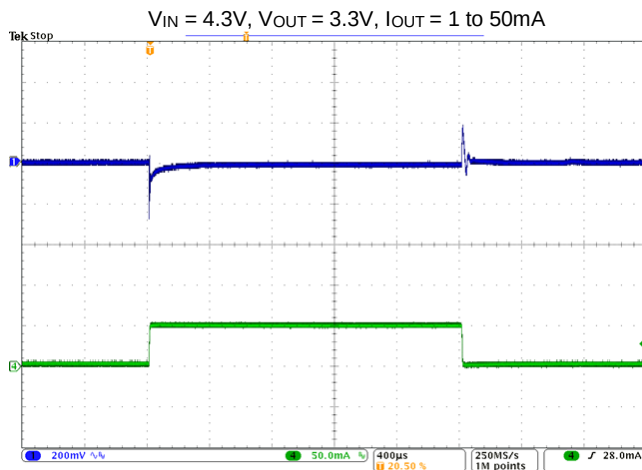


Load Transient Response ($C_{IN} = C_{OUT} = 0.1\mu F$, $t_R = t_F = 5.0\mu s$, unless otherwise specified.)

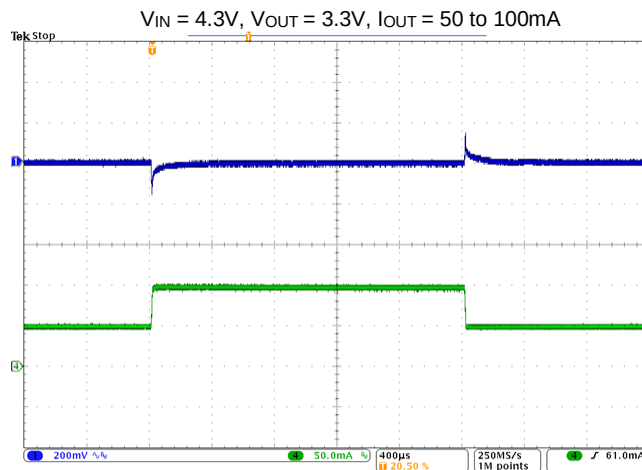


Performance Characteristics (continued)

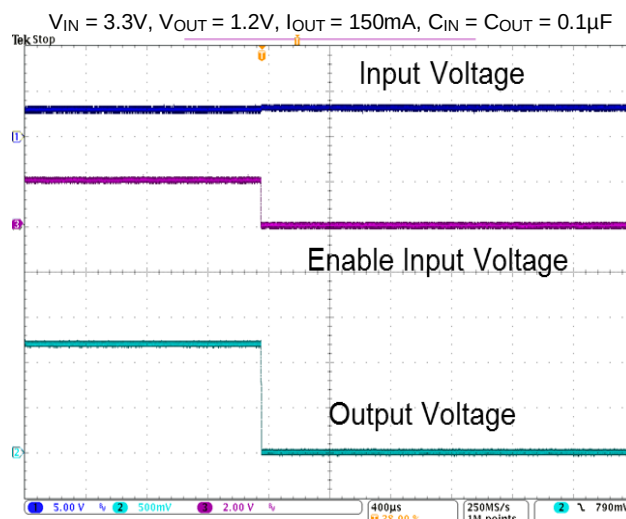
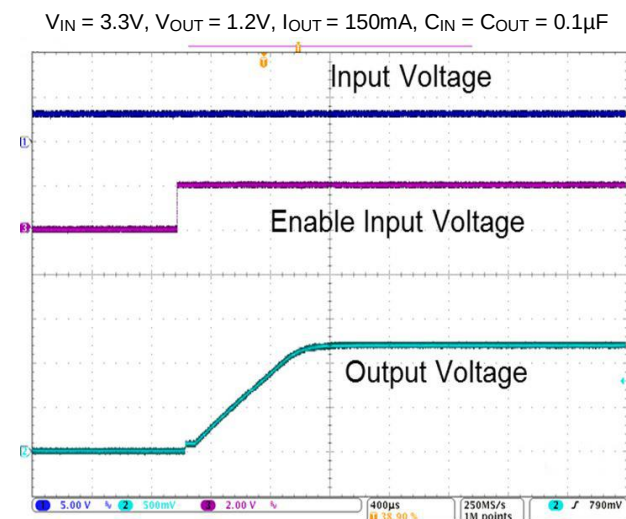
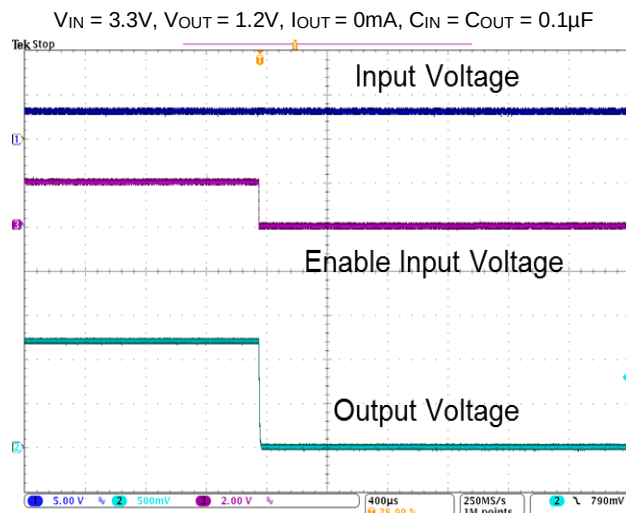
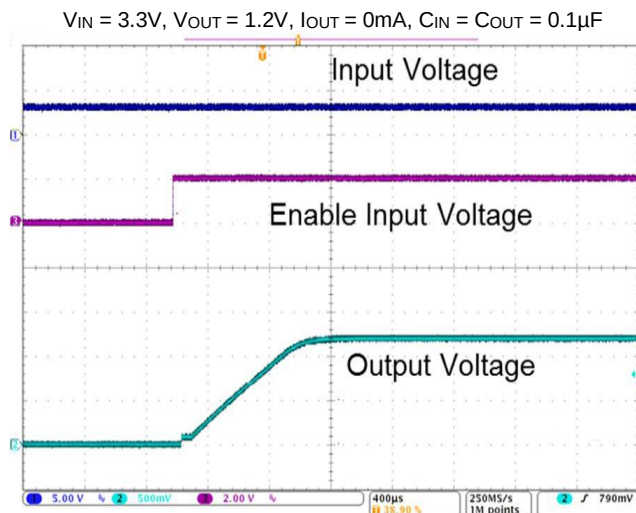
Load Transient Response ($C_{IN} = C_{OUT} = 0.1\mu F$, $t_R = t_F = 5.0\mu s$, unless otherwise specified.)



Turn On

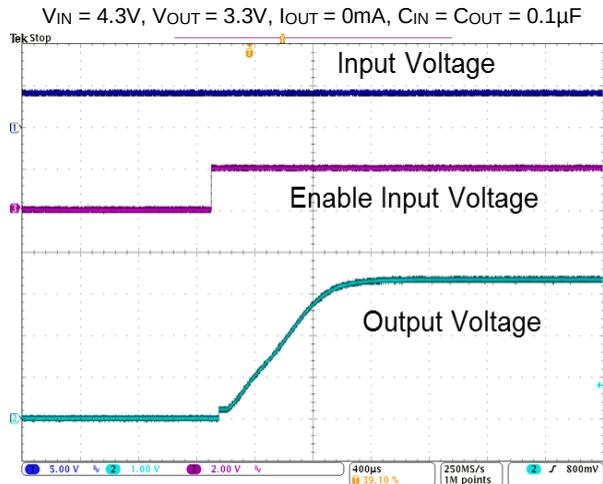


Turn Off

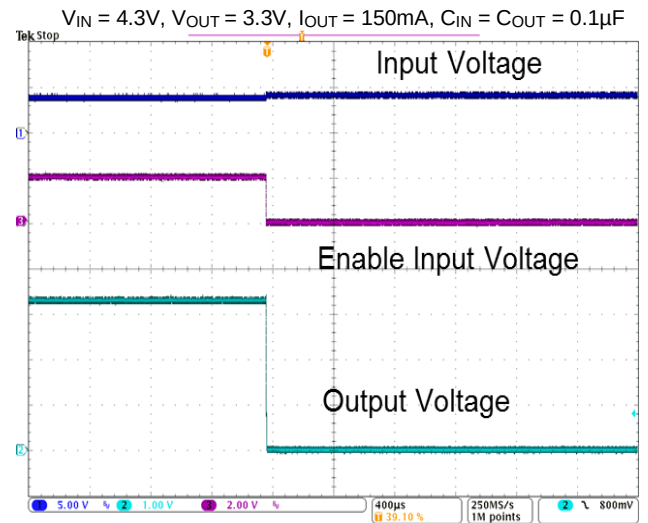
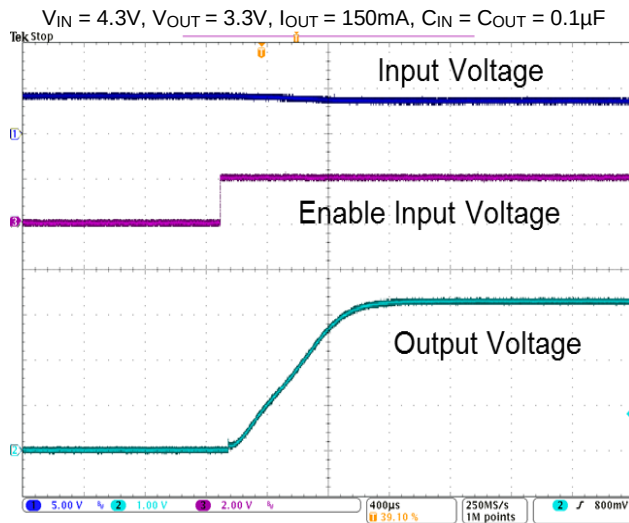
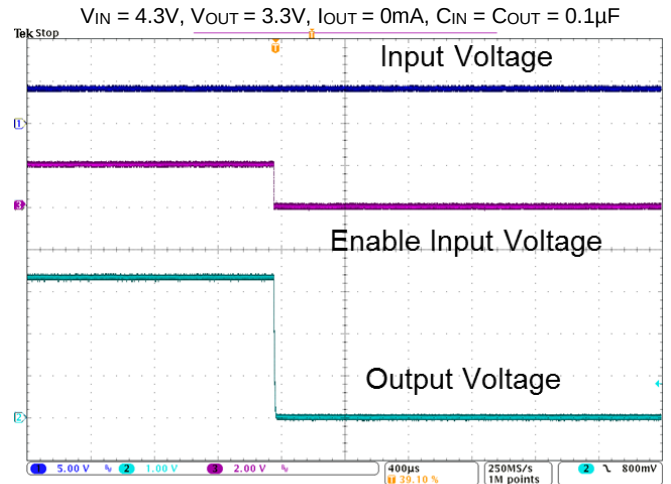


Performance Characteristics (continued)

Turn On



Turn Off



Application Information

Output Capacitor

An output capacitor (C_{OUT}) is needed to improve transient response and maintain stability. The AP7350 is stable with very small ceramic output capacitors. The ESR (Equivalent Series Resistance) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pin and care should be taken to reduce the impedance in the layout.

Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor (C_{IN}). A minimum 0.1 μ F ceramic capacitor is recommended between V_{IN} and GND pin to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND pin.

Enable Control

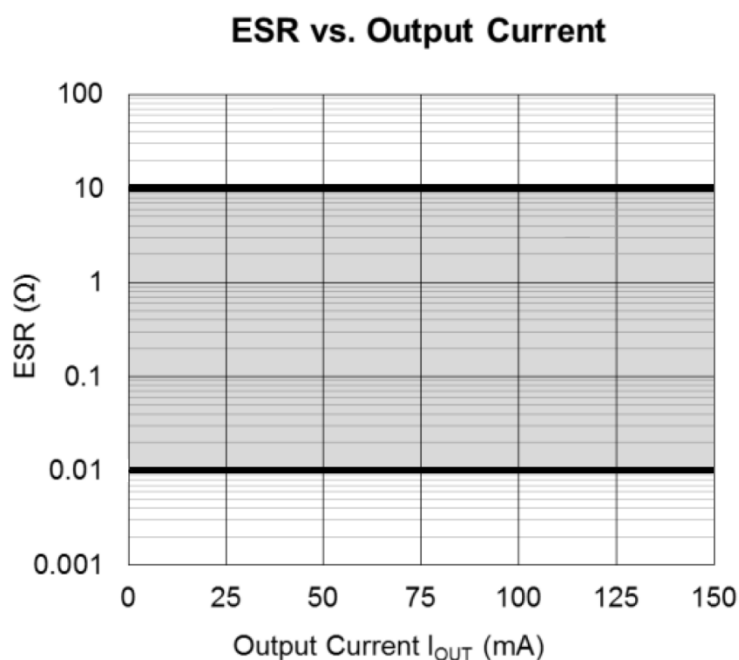
The AP7350 is turned on by setting the EN pin high, and is turned off by pulling it low. If this feature is not used, the EN pin should be tied to V_{IN} pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the *Electrical Characteristics* section.

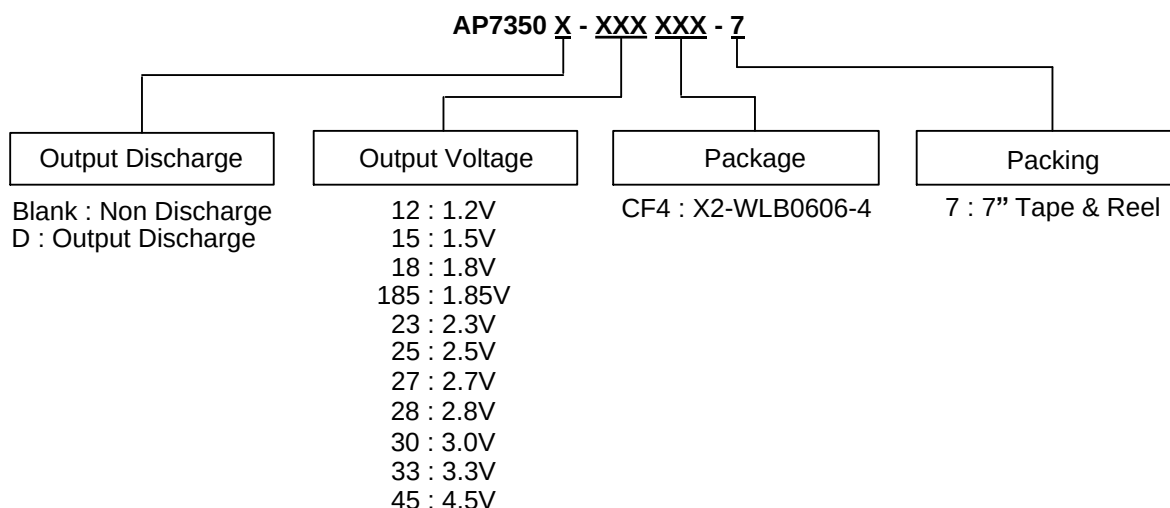
Layout Considerations

For good ground loop and stability, the input and output capacitors should be located close to the input, output, and GND pin of the device. The regulator GND pin should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace should be used for large current paths from V_{IN} to V_{OUT} , and load circuit.

ESR vs. Output Current

A ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph. Measurement conditions: Frequency Band: 10Hz to 2MHz, Temperature: -40°C to +85°C.



Ordering Information (Note 13)


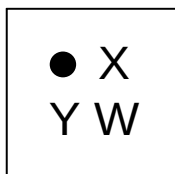
Device Without Discharge	Device With Discharge	Output Voltage	Package Code	Package	7" Tape and Reel	
					Quantity	Part Number Suffix
AP7350-12CF4-7	AP7350D-12CF4-7	1.2	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-15CF4-7	AP7350D-15CF4-7	1.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-18CF4-7	AP7350D-18CF4-7	1.8	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-185CF4-7	AP7350D-185CF4-7	1.85	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-23CF4-7	AP7350D-23CF4-7	2.3	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-25CF4-7	AP7350D-25CF4-7	2.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-27CF4-7	AP7350D-27CF4-7	2.7	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-28CF4-7	AP7350D-28CF4-7	2.8	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-30CF4-7	AP7350D-30CF4-7	3.0	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-33CF4-7	AP7350D-33CF4-7	3.3	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7
AP7350-45CF4-7	AP7350D-45CF4-7	4.5	CF4	X2-WLB0606-4	3,000/Tape & Reel	-7

Note: 13. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

(1) X2-WLB0606-4

(Top View)



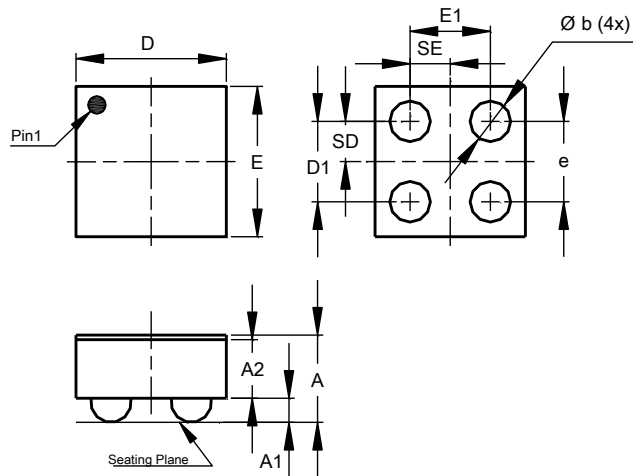
X or $\bar{X}$: Identification Code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week

Part Number	V _{OUT}	Package	Identification Code
AP7350-12CF4-7	1.2V	X2-WLB0606-4	A
AP7350-15CF4-7	1.5V	X2-WLB0606-4	B
AP7350-18CF4-7	1.8V	X2-WLB0606-4	C
AP7350-185CF4-7	1.85V	X2-WLB0606-4	R
AP7350-23CF4-7	2.3V	X2-WLB0606-4	9
AP7350-25CF4-7	2.5V	X2-WLB0606-4	D
AP7350-27CF4-7	2.7V	X2-WLB0606-4	$\bar{A}$
AP7350-28CF4-7	2.8V	X2-WLB0606-4	E
AP7350-30CF4-7	3.0V	X2-WLB0606-4	F
AP7350-33CF4-7	3.3V	X2-WLB0606-4	G
AP7350-45CF4-7	4.5V	X2-WLB0606-4	7
AP7350D-12CF4-7	1.2V	X2-WLB0606-4	H
AP7350D-15CF4-7	1.5V	X2-WLB0606-4	J
AP7350D-18CF4-7	1.8V	X2-WLB0606-4	K
AP7350D-185CF4-7	1.85V	X2-WLB0606-4	S
AP7350D-23CF4-7	2.3V	X2-WLB0606-4	$\bar{9}$
AP7350D-25CF4-7	2.5V	X2-WLB0606-4	L
AP7350D-27CF4-7	2.7V	X2-WLB0606-4	$\bar{B}$
AP7350D-28CF4-7	2.8V	X2-WLB0606-4	M
AP7350D-30CF4-7	3.0V	X2-WLB0606-4	N
AP7350D-33CF4-7	3.3V	X2-WLB0606-4	P
AP7350D-45CF4-7	4.5V	X2-WLB0606-4	8

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-WLB0606-4

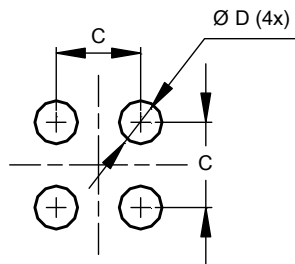


X2-WLB0606-4			
Dim	Min	Max	Typ
A	0.300	0.380	0.340
A1	0.075	0.105	0.090
A2	0.205	0.255	0.230
b	0.110	0.190	0.150
D	0.625	0.655	0.640
D1	0.300	0.400	0.350
E	0.625	0.655	0.640
E1	0.300	0.400	0.350
e	0.350 BSC		
SD	0.175 BSC		
SE	0.175 BSC		
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

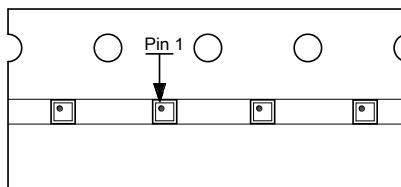
X2-WLB0606-4



Dimensions	Value (in mm)
C	0.350
D	0.150

Tape Orientation

The taping orientation of the other package type can be found on our website at <https://www.diodes.com/assets/Packaging-Support-Docs/Ap02007.pdf>.



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